Unit: mm

TOSHIBA Infrared LED GaAlAs Infrared Emitter

TLN233(F)

Lead-Free Product Infrared LED for Space-Optical-Transmission

- High radiant intensity: 80 mW/sr (typ.) at IF = 50 mA
- Half-angle value: $\theta 1/2 = \pm 13^{\circ}$ (typ.)
- A light source for remote control
- Wireless AV-signal transmission purposes
- High-speed data transmission purposes

Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit	
Forward current	l _F	100	mA	
Pulse forward current	I _{FP}	1000 (Note 1)	mA	
Power dissipation	P_{D}	200	mW	
Reverse voltage	V_{R}	4	V	
Operating temperature range	T _{opr}	-25~85	°C	
Storage temperature range	T _{stg}	-30~100	°C	
Soldering temperature (5 s), (Note 2)	T _{sol}	260	°C	

Note 1: f = 100 kHz, duty = 1%

Note 2: Soldering must be performed under the stopper.

* (Includes resin-mold portion)

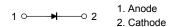
(): REFERENCE VALUE

* TOSHIBA

4-5V3

Weight: 0.3 g (typ.)

Pin Connection



Optical and Electrical Characteristics (Ta = 25°C)

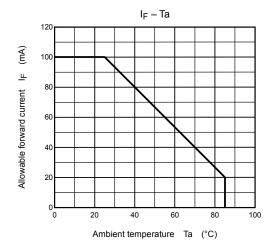
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward voltage	V _F	I _F = 100 mA	_	1.6	2.0	V
Reverse current	I _R	V _R = 4 V	_	_	60	μА
Radiant intensity	ΙE	I _F = 50 mA	46	80	_	mW/sr
Radiant power	PO	I _F = 50 mA	_	30	_	mW
Cut-off frequency	f _C	$I_F = 50 \text{ mA} + 5 \text{ mA}_{P-P}$ (Note 3)	_	15	_	MHz
Peak emission wavelength	λР	I _F = 50 mA	_	870	_	nm
Half-angle value	$\theta \frac{1}{2}$	I _F = 50 mA	_	±13	_	۰

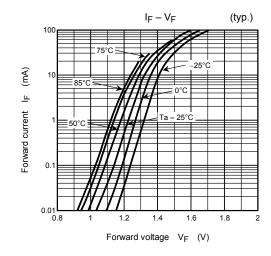
Note 3: This is the frequency when modulation light power decreases by 3 dB from 1 MHz.

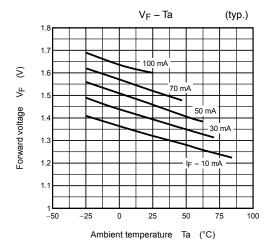
Handling Precautions

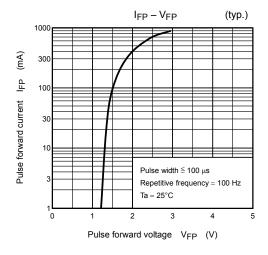
- Soldering must be performed under the stopper.
- When forming the leads, bend each lead at least 5 mm from the package body. Soldering must be performed after the leads have been formed.
- The radiant intensity decreases over time due to current flowing in the infrared LED. When designing circuits, take into account the change in radiant intensity over time. The change in radiant intensity is equal to the reciprocal of the change in LED infrared optical output:

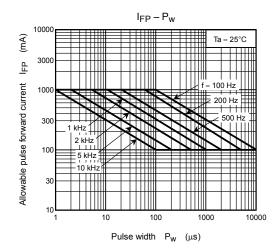
$$\frac{\mathrm{IE}\left(t\right)}{\mathrm{IE}\left(0\right)} = \frac{\mathrm{P}_{\mathrm{O}}\left(t\right)}{\mathrm{P}_{\mathrm{O}}\left(0\right)} \,.$$

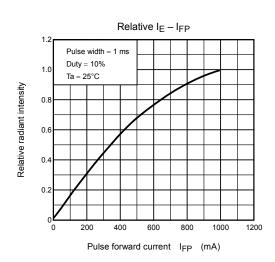




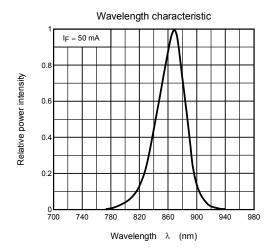


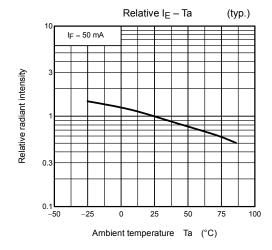


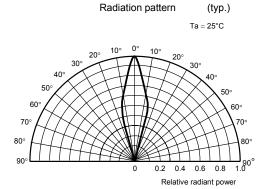




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